| ASSOCIATION CONNECTING<br>ELECTROMICS INDUSTRIES International and Pan- | C. Bannockh   | ourn, Illinois, A         | ll rights reserved untions. | under both    | This docum<br>level parts, t  | ent is a declarati<br>the declaration e | on of the su                              | bstances v<br>s all lower | vithin the manufactu<br>level materials for v | rer listed | tem. Note:<br>nanufactur        | if the item is an as<br>er has engineering | sembly with low responsibility. |  |
|---|---|---------------------------|-----------------------------|---------------|---|---|---|---------------------------|---|------------|---------------------------------|--|---------------------------------|--|
|   | 21.1 IPC Web Site for Information on IPC-1752 Standard For<br>http://www.ipc.org/IPC-175x Dis |                           |                             |               | e * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information |   |   |                           |   | ation      |                                 |  |                                 |  |
| Supplier Information  |   |                           |                             |               |   |   |   |                           |   |            |                                 |  |                                 |  |
| Company name* Com   |   |                           | Company unique ID           |               |   | Unique ID Authority                     |   |                           |   | Respon     | Response Date*                  |  |                                 |  |
| nsemi   |   |                           |                             |               |   |   |   |                           |   |            | 2023-06-08                      |  |                                 |  |
| Contact Name  | zt Name Title - Contact   |                           |                             |               |   | Phone - Contact*                        |   |                           |   | Email -    | Email - Contact*                |  |                                 |  |
| roduct-Env-Stewards Product Enviro Com                                  |   |                           | ro Compliance               | Compliance    |   |   | NA  |                           |   |            | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Authorized Representative* Title - Representative                       |   |                           | sentative                   | tative P      |   | Phone - Representative*                 |   |                           | Email - Representative*                       |            |                                 |  |                                 |  |
| Product-Env-Stewards Produ  |   |                           | Product Enviro Compliance   |               |   | NA                                      |   |                           |   | Produ      | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Requester Item Number   | Mfr Item  | Number                    | Mfr Item Name               |               |   | Effective Date                          | Version                                   | М                         | lanufacturing Site                            |            | Weight*                         | UOM  | Unit Type                       |  |
|   | NB6L29  | B6L295MMNTXG CML DUAL PRO |                             | OG DELAY      | Y 2023-06   |   |   | М                         | MY1   |            | 44.91                           | mg   | Each                            |  |
| Ianufacturing Proccess Informati  | on  |                           |                             |               |   |   |   |                           |   |            |                                 |  |                                 |  |
| Terminal Plating / Grid Array Mat                                       | erial T   | al Terminal Base Alloy    |                             | J-STD-020 MSI | L Rating  | Peak Proce                              | Process Body Temperature Max Time at Peak |                           | c Tempera                                     | ture Nun   | nber of Reflow Cyc              | les  |                                 |  |
| Matte Tin (Sn) - annealed CU Alloy                                      |   | CU Alloy                  |                             | 1             |   | 260                                     |   | С                         | 30  | seco       | nds 3                           |  |                                 |  |
| omments   |   |                           |                             |               |   |   |   |                           |   |            |                                 |  |                                 |  |
| vel 1 - maximum time at peak temperatur                                 | e during so   | Idering is 10-3           | 0 seconds                   |               |   |   |   |                           |   |            |                                 |  |                                 |  |
| or more information regarding material c                                | omposition  | please refer to           | page 3                      |               |   |   |   |                           |   |            |                                 |  |                                 |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | mogeneous Material Weight Unit of Meas |    | Level    | Substance  | CAS         | Exempt | Weight  | Unit of Measure |
|----------------------|--|----|----------|--|-------------|--------|---------|-----------------|
| Die                  | 2.98                                   | mg | Supplier | Silicon (Si)   | 7440-21-3   |        | 2.98    | mg              |
| Die Attach           | 0.55                                   | mg | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1 |        | 0.11    | mg              |
|                      |  |    | Supplier | Silver (Ag)  | 7440-22-4   |        | 0.44    | mg              |
| Lead Frame           | 16.85                                  | mg | Supplier | Silver (Ag)  | 7440-22-4   |        | 0.1685  | mg              |
|                      |  |    | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.0421  | mg              |
|                      |  |    | Supplier | Zinc (Zn)  | 7440-66-6   |        | 0.0371  | mg              |
|                      |  |    | Supplier | Chromium (Cr)  | 7440-47-3   |        | 0.0421  | mg              |
|                      |  |    | Supplier | Copper (Cu)  | 7440-50-8   |        | 16.5602 | mg              |
| Mold Compound-Black  | 22.31                                  | mg | Supplier | Epoxy and Phenolic Resin   | 40216-08-8  |        | 1.7848  | mg              |
|                      |  |    | Supplier | Carbon Black (C)   | 1333-86-4   |        | 0.1115  | mg              |
|                      |  |    | Supplier | Aluminum Hydroxide (Al(OH)3)                                       | 21645-51-2  |        | 0.4462  | mg              |
|                      |  |    | Supplier | Fused Silica (SiO2)  | 60676-86-0  |        | 19.2981 | mg              |
|                      |  |    | Supplier | Phenolic Resin (Novolac)   | 9003-35-4   |        | 0.6693  | mg              |
| Plating              | 1.89                                   | mg | Supplier | Tin (Sn)   | 7440-31-5   |        | 1.89    | mg              |
| Wire Bond - Au       | 0.33                                   | mg | Supplier | Gold (Au)  | 7440-57-5   |        | 0.33    | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).